

## TSSOP-8 30V Dual N Channel Enhancement 共漏双N沟道增强型 MOS Field Effect Transistor 场效应管

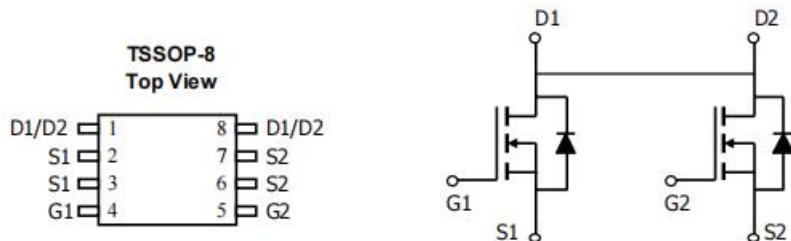
### ■ Features 特点

Trench technology 沟槽工艺  
 Low on-resistance 低导通电阻  
 $R_{DS(ON)}=12m\Omega$ (Type)@ $V_{GS}=10V$   
 $R_{DS(ON)}=17m\Omega$ (Type)@ $V_{GS}=4.5V$

### ■ Applications 应用

Load Switch 负载开关  
 PWM Application 脉宽调制应用  
 DC/DC Conversion 直流/直流升压转换  
 Power Management in portable/desktop PCs 便携/台式电脑电源管理

### ■ Internal Schematic Diagram 内部结构



### ■ Absolute Maximum Ratings 最大额定值

| Characteristic 特性参数                    | Symbol 符号                      | Rating 额定值 | Unit 单位 |
|--|--------------------------------|------------|---------|
| Drain-Source Voltage 漏极-源极电压           | $BV_{DSS}$                     | 30         | V       |
| Gate- Source Voltage 栅极-源极电压           | $V_{GS}$                       | $\pm 20$   | V       |
| Drain Current (continuous)漏极电流-连续      | $I_D$ (at $T_A = 25^\circ C$ ) | 8          | A       |
| Drain Current (pulsed)漏极电流-脉冲          | $I_{DM}$                       | 32         | A       |
| Total Device Dissipation 总耗散功率         | $P_D$ (at $T_A = 25^\circ C$ ) | 1500       | mW      |
| Thermal Resistance Junction-Ambient 热阻 | $R_{\theta JA}$                | 83         | °C/W    |
| Junction/Storage Temperature 结温/储存温度   | $T_J, T_{stg}$                 | -55~150    | °C      |



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FS8816

## ■ Electrical Characteristics 电特性

( $T_A=25^\circ\text{C}$  unless otherwise noted 如无特殊说明, 温度为  $25^\circ\text{C}$ )

| Characteristic<br>特性参数   | Symbol<br>符号             | Min<br>最小值 | Typ<br>典型值 | Max<br>最大值 | Unit<br>单位       |
|--|--------------------------|------------|------------|------------|------------------|
| Drain-Source Breakdown Voltage<br>漏极-源极击穿电压( $I_D=250\mu\text{A}, V_{GS}=0\text{V}$ )  | $\text{BV}_{\text{DSS}}$ | 30         | —          | —          | V                |
| Gate Threshold Voltage<br>栅极开启电压( $I_D=250\mu\text{A}, V_{GS}=V_{DS}$ )  | $V_{GS(\text{th})}$      | 1          | 1.5        | 2.4        | V                |
| Zero Gate Voltage Drain Current<br>零栅压漏极电流( $V_{GS}=0\text{V}, V_{DS}=30\text{V}$ )  | $I_{\text{DSS}}$         | —          | —          | 1          | $\mu\text{A}$    |
| Gate Body Leakage<br>栅极漏电流( $V_{GS}=\pm 20\text{V}, V_{DS}=0\text{V}$ )  | $I_{GSS}$                | —          | —          | $\pm 10$   | $\mu\text{A}$    |
| Static Drain-Source On-State Resistance<br>静态漏源导通电阻( $I_D=8\text{A}, V_{GS}=10\text{V}$ )<br>( $I_D=5\text{A}, V_{GS}=4.5\text{V}$ ) | $R_{DS(\text{ON})}$      | —          | 12<br>17   | 16<br>23   | $\text{m}\Omega$ |
| Diode Forward Voltage Drop<br>内附二极管正向压降( $I_{SD}=1\text{A}, V_{GS}=0\text{V}$ )  | $V_{SD}$                 | —          | —          | 1.5        | V                |
| Input Capacitance 输入电容<br>( $V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$ )   | $C_{\text{iss}}$         | —          | 1130       | —          | pF               |
| Common Source Output Capacitance<br>共源输出电容( $V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$ )                                   | $C_{\text{oss}}$         | —          | 170        | —          | pF               |
| Reverse Transfer Capacitance<br>反馈电容( $V_{GS}=0\text{V}, V_{DS}=15\text{V}, f=1\text{MHz}$ )   | $C_{RSS}$                | —          | 125        | —          | pF               |
| Total Gate Charge 棚极电荷密度<br>( $V_{DS}=15\text{V}, I_D=8\text{A}, V_{GS}=4.5\text{V}$ )   | $Q_g$                    | —          | 15         | —          | nC               |
| Gate Source Charge 棚源电荷密度<br>( $V_{DS}=15\text{V}, I_D=8\text{A}, V_{GS}=4.5\text{V}$ )  | $Q_{gs}$                 | —          | 1.8        | —          | nC               |
| Gate Drain Charge 棚漏电荷密度<br>( $V_{DS}=15\text{V}, I_D=8\text{A}, V_{GS}=4.5\text{V}$ )   | $Q_{gd}$                 | —          | 5.5        | —          | nC               |
| Turn-ON Delay Time 开启延迟时间<br>( $V_{DS}=15\text{V}, I_D=6\text{A}, R_{\text{GEN}}=3\ \Omega, V_{GS}=4.5\text{V}$ )                    | $t_{d(\text{on})}$       | —          | 5.8        | —          | ns               |
| Turn-ON Rise Time 开启上升时间<br>( $V_{DS}=15\text{V}, I_D=6\text{A}, R_{\text{GEN}}=3\ \Omega, V_{GS}=4.5\text{V}$ )                     | $t_r$                    | —          | 5          | —          | ns               |
| Turn-OFF Delay Time 关断延迟时间<br>( $V_{DS}=15\text{V}, I_D=6\text{A}, R_{\text{GEN}}=3\ \Omega, V_{GS}=4.5\text{V}$ )                   | $t_{d(\text{off})}$      | —          | 36         | —          | ns               |
| Turn-OFF Fall Time 关断下降时间<br>( $V_{DS}=15\text{V}, I_D=6\text{A}, R_{\text{GEN}}=3\ \Omega, V_{GS}=4.5\text{V}$ )                    | $t_f$                    | —          | 8          | —          | ns               |

## ■ Typical Characteristic Curve 典型特性曲线

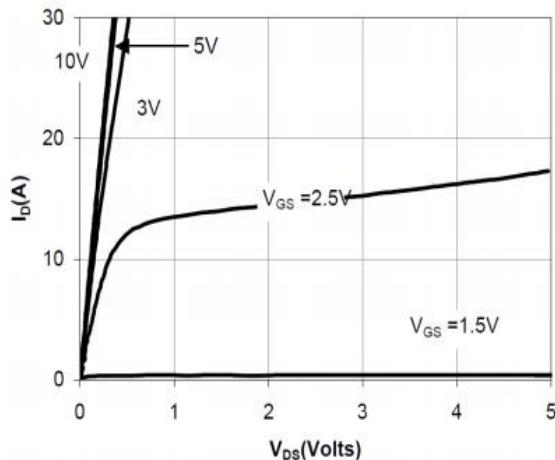


Figure 1: Output Characteristics

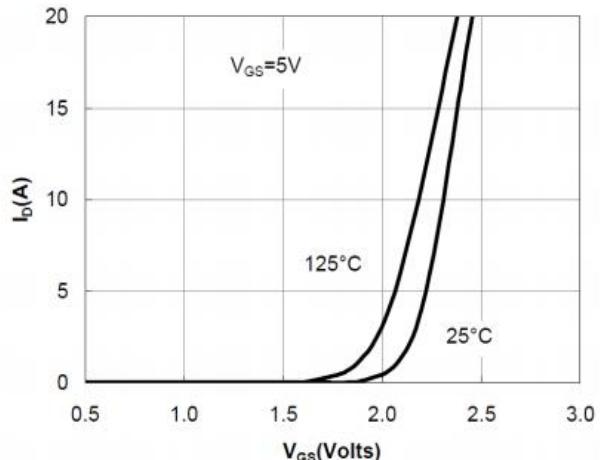


Figure 2: Transfer Characteristics

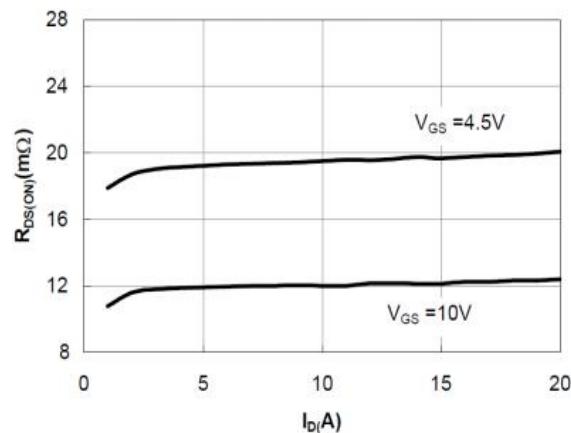


Figure 3: On-Resistance vs. Drain Current

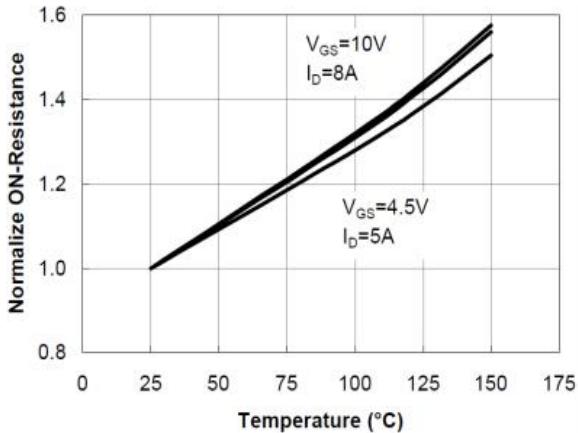


Figure 4: On-Resistance vs. Temperature

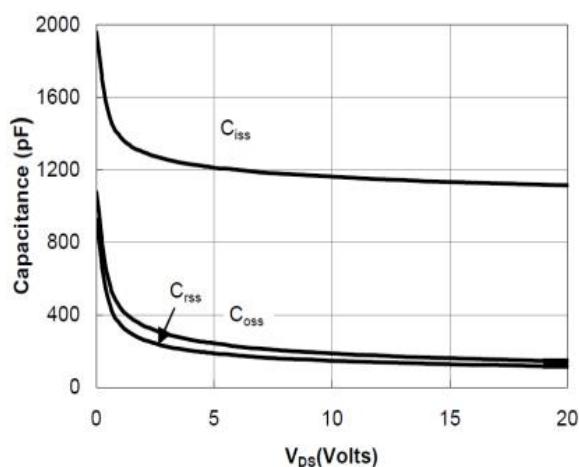


Figure 5: Capacitance Characteristics

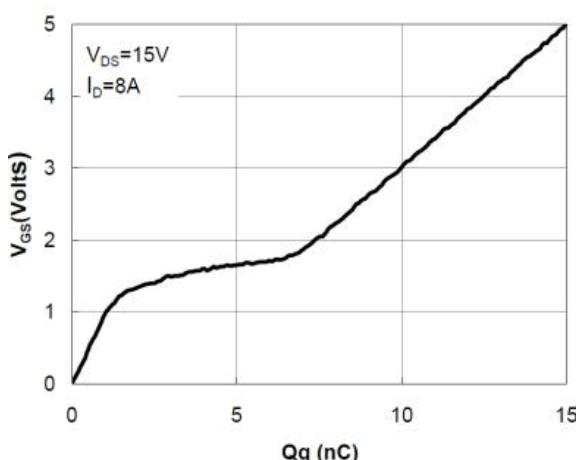
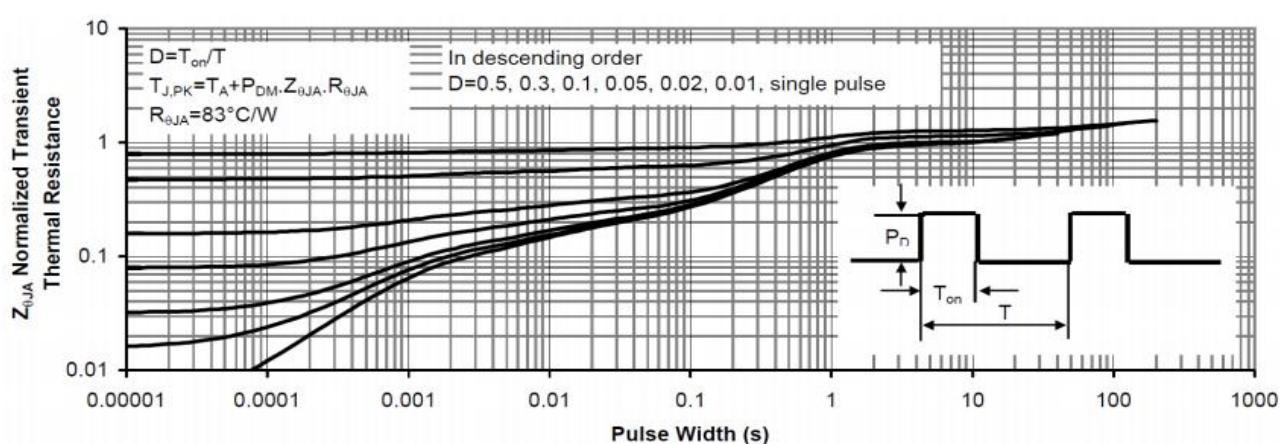
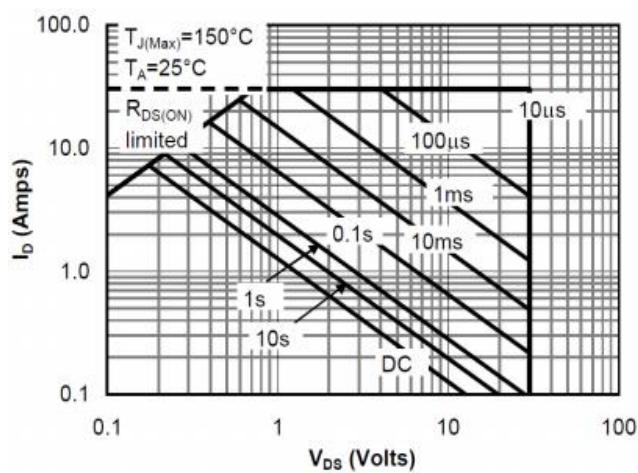
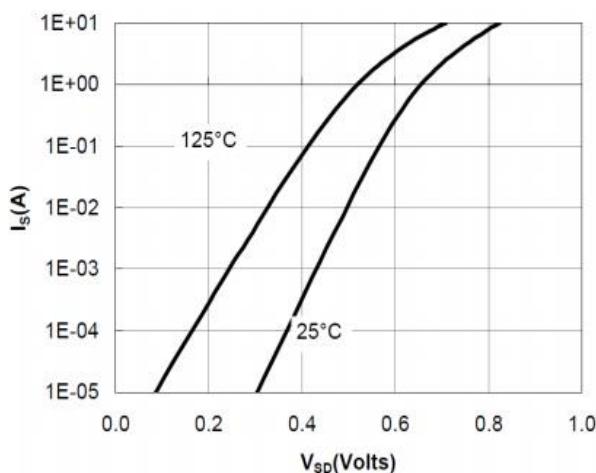
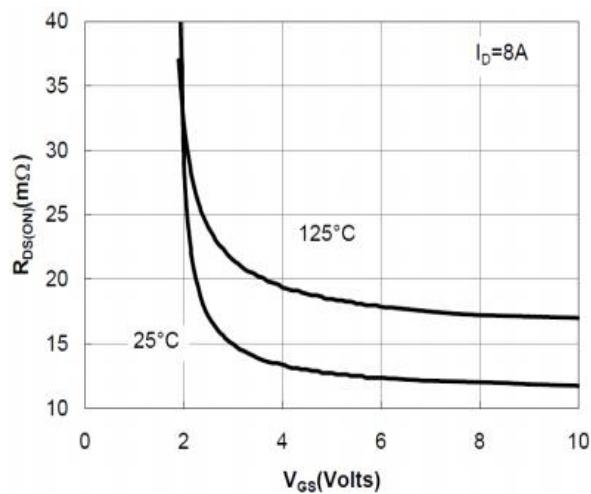
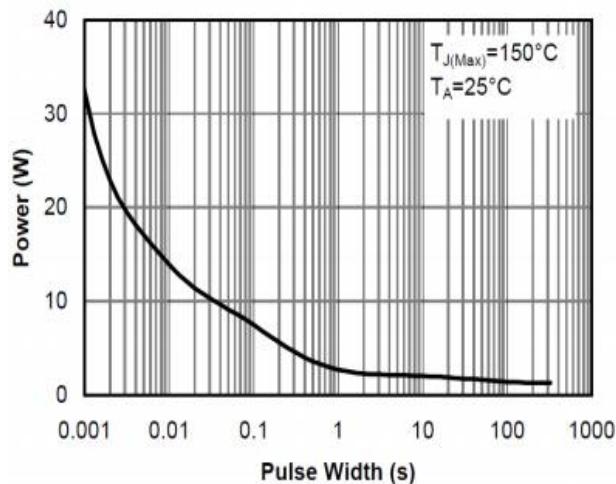
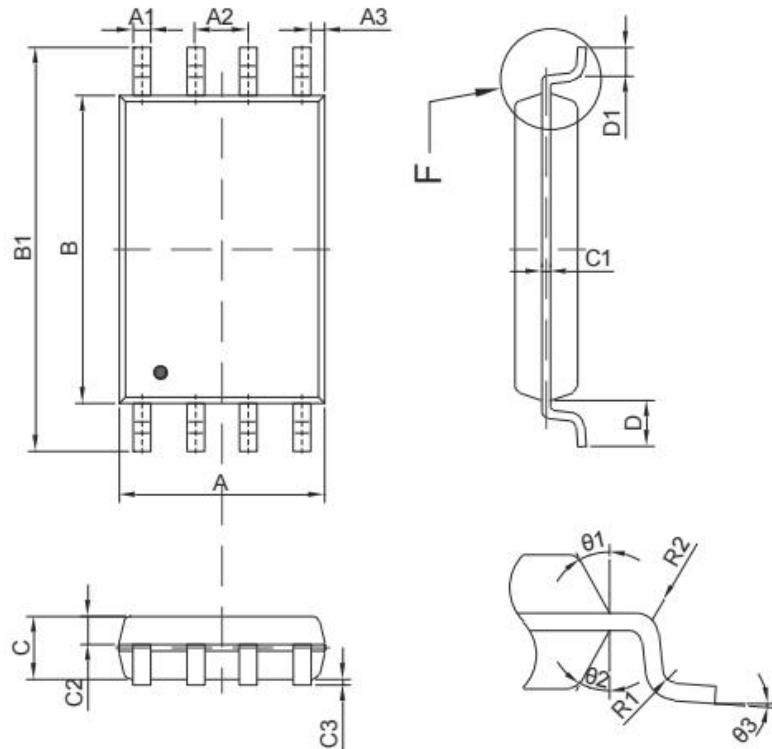


Figure 6: Gate-Charge Characteristics

■ Typical Characteristic Curve 典型特性曲线



■ Dimension 外形封装尺寸



Detail "F"

| Symbol | Millimeters |      | Symbol | Millimeters |      |
|--------|-------------|------|--------|-------------|------|
|        | Min         | Max  |        | Min         | Max  |
| A      | 2.90        | 3.10 | C3     | 0.05        | 0.15 |
| A1     | 0.20        | 0.30 | D      | 1.00 REF    |      |
| A2     | 0.65 TYP    |      | D1     | 0.50        | 0.70 |
| A3     | 0.36        | 0.46 | R1     | 0.15 TYP    |      |
| B      | 4.30        | 4.50 | R2     | 0.15 TYP    |      |
| B1     | 6.30        | 6.50 | θ1     | 12° TYP     |      |
| C      | 0.95        | 1.05 | θ2     | 12° TYP     |      |
| C1     | 0.127 TYP   |      | θ3     | 0° ~ 7°     |      |
| C2     | 0.39        | 0.49 |        |             |      |